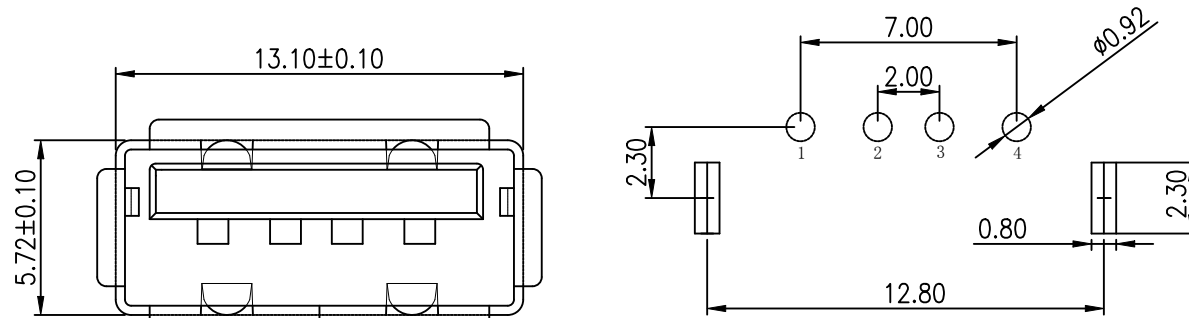
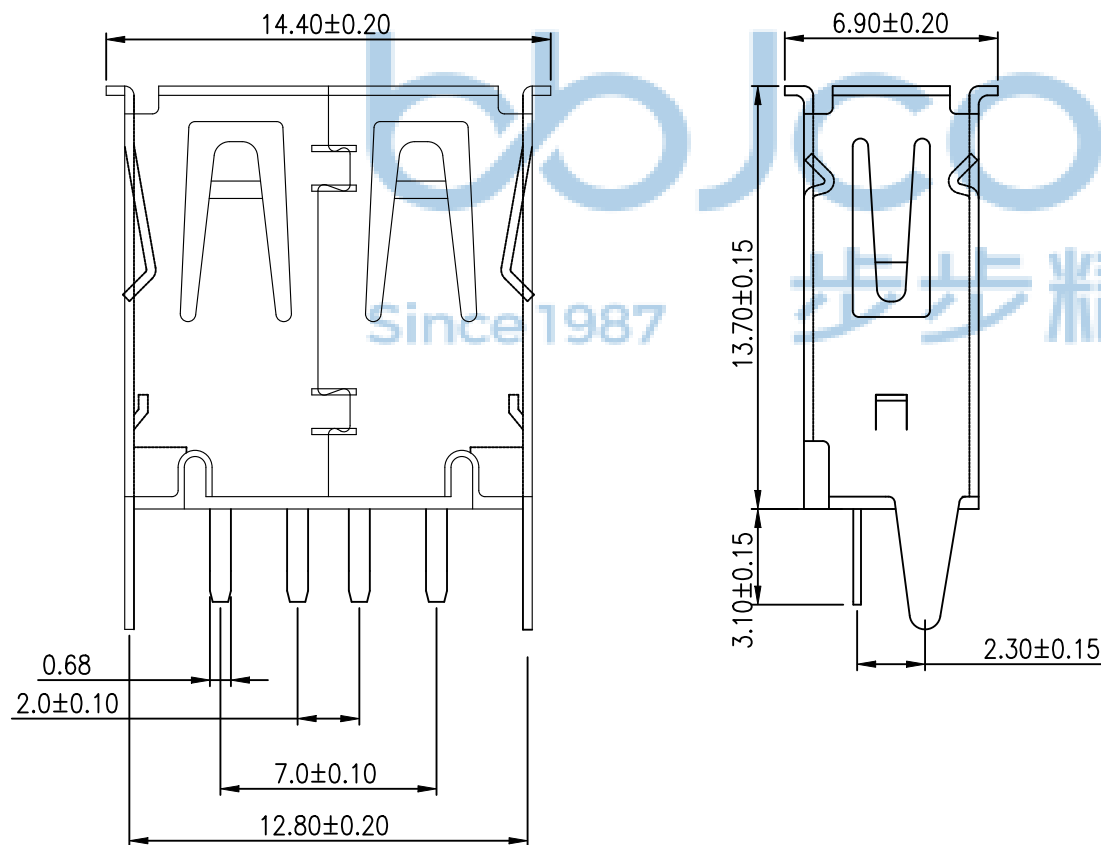


REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0				



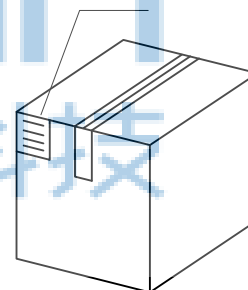
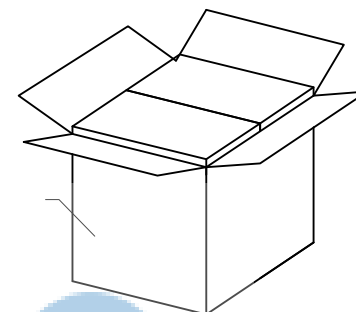
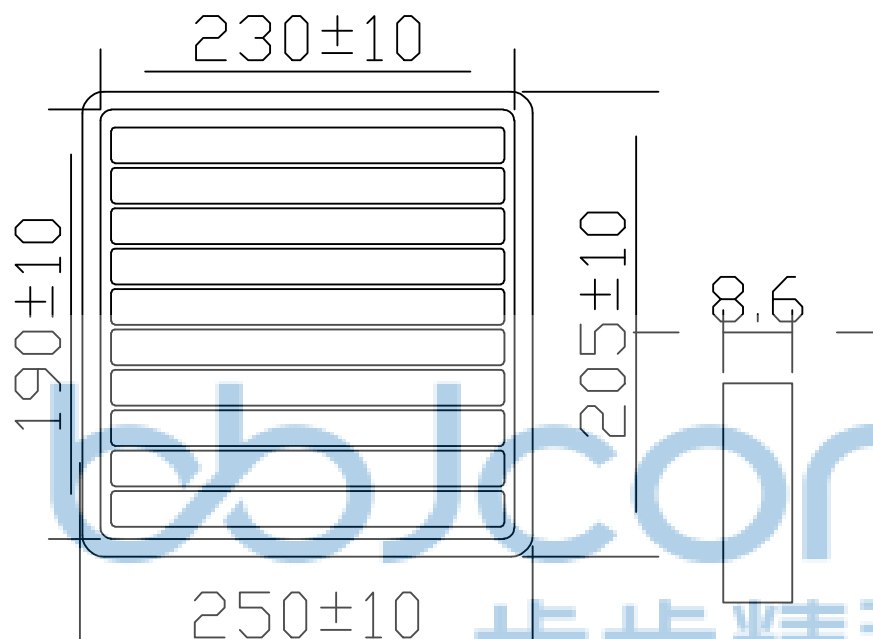
P. C. B LAYOUT



特性: Specifications;
 电器: Electyical:
 接触阻抗: Contact Resistance
 30 millionms MAX
 耐电压: Dielectric Withstanding Voltage:
 500v AC AT Sea Level
 绝缘阻抗: Insulation Resistance:
 1000 MEGA ohms MLN
 机构: Machanical:
 接合为: Mating Force;
 3. 75KG MAX 最大3. 75Kg
 拔出力: Unmating Force;
 1. 02KG MIN. 最少1. 02KG
 材料: Matorial:
 塑胶: Housing: High Temperatuye Thermoplastics
 端子: Contact: Copper Alloy 铜合金 C2680
 铁壳: Shell: Copper Alloy 铜合金 C2680/SPCC
 电镀: Finish:
 端子: Contact: Plated Gold in Mating Area;
 Tin/On Solder Tails
 接触点镀金; 脚镀锡
 外壳: Shell:
 nickel Plating 镀镍



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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X*: ±3* .X*: ±2* .XX*: ±1*	
APPD.	JM_Zheng	NAME: USB 2.0 AF 180度 H=13.70 直脚直插 端子DIP 卷边 LCP蓝胶 铜壳	
CHKD.	LYX	PJ. NO.: UB.01.11-32-V005	
DR.	TSP	SIZE: A4 DRW NO.:	
PDWG.NO: 0383-1		FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2	



1. 包装要求:
- 1.1 每盒吸塑盒包装100pcs;
 - 1.2 每20盘放一箱, 共计2000PCS;
 - 1.3 纸箱外贴上标签。

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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X*: ±3" .X*: ±2" .XX*: ±1"		PJ. NO.: UB.01.11-32-V005	
APPD. JM_Zheng		CHKD. LYX		SIZE: A4 DRW NO.:	
DR. TSP		FINISH: SEE NOTES		MAT'L.: SEE NOTES	
SCALE: N/A		REV.: A0		UNIT: mm	
PAGE: 2/2					